

2 MHz / 3 MHz Ultra Small Step Down Converter in 1x1.5 SON Package

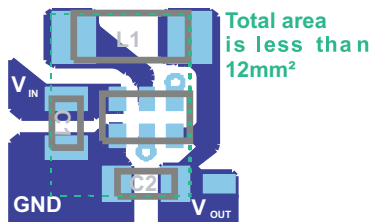
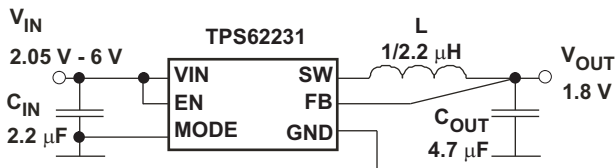
Check for Samples: [TPS62230](#), [TPS62231](#), [TPS62232](#), [TPS62233](#),
[TPS62234](#), [TPS62235](#), [TPS62236](#), [TPS62237](#), [TPS62238](#), [TPS62239](#), [TPS622310](#), [TPS622311](#)

FEATURES

- 2 MHz / 3 MHz Switch Frequency
- Up to 94% Efficiency
- Output Peak Current up to 500mA
- Excellent AC and Transient Load Regulation
- High PSRR (up to 90dB)
- Small External Output Filter Components 1 μ H/ 4.7 μ F
- V_{IN} range from 2.05V to 6V
- Optimized Power Save Mode For Low Output Ripple Voltage
- Forced PWM Mode Operation
- Typ. 22 μ A Quiescent Current
- 100% Duty Cycle for Lowest Dropout
- Small 1 x 1.5 x 0.6mm³ SON Package
- 12 mm² Minimum Solution Size
- Supports 0.6 mm Maximum Solution Height
- Soft Start with typ. 100 μ s Start Up Time

APPLICATIONS

- LDO Replacement
- Portable Audio, Portable Media
- Cell Phones
- Low Power Wireless
- Low Power DSP Core Supply
- Digital Cameras



DESCRIPTION

The TPS6223X device family is a high frequency synchronous step down DC-DC converter optimized for battery powered portable applications. It supports up to 500mA output current and allows the use of tiny and low cost chip inductors and capacitors.

With a wide input voltage range of 2.05V to 6V the device supports applications powered by Li-Ion batteries with extended voltage range. The minimum input voltage of 2.05V allows as well the operation from Li-primary or two alkaline batteries. Different fixed output voltage versions are available from 1.2V to 2.5V.

The TPS6223X series features switch frequency up to 3.8MHz. At medium to heavy loads, the converter operates in PWM mode and automatically enters Power Save Mode operation at light load currents to maintain high efficiency over the entire load current range.

Because of its excellent PSRR and AC load regulation performance, the device is also suitable to replace linear regulators to obtain better power conversion efficiency.

The Power Save Mode in TPS6223X reduces the quiescent current consumption down to 22 μ A during light load operation. It is optimized to achieve very low output voltage ripple even with small external component and features excellent ac load regulation.

For very noise sensitive applications, the device can be forced to PWM Mode operation over the entire load range by pulling the MODE pin high. In the shutdown mode, the current consumption is reduced to less than 1 μ A. The TPS6223X is available in a 1 x 1.5mm² 6 pin SON package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

ORDERING INFORMATION

T _A	PART NUMBER ⁽¹⁾	OUTPUT VOLTAGE ⁽²⁾	FREQUENCY [MHz]	PACKAGE DESIGNATOR	ORDERING	PACKAGE MARKING
-40°C to 85°C	TPS62230	2.5 V	3	DRY	TPS62230DRY	GV
	TPS62231	1.8 V	3	DRY	TPS62231DRY	GW
	TPS62232	1.2 V	3	DRY	TPS62232DRY	GX
	TPS62239	1.0 V	3	DRY	TPS62239DRY	OP
	TPS622311	1.1V	2	DRY	TPS622311DRY	PA
	TPS62235	1.2V	2	DRY	TPS62235DRY	OQ
	TPS6223-1.3 ⁽³⁾	1.3 V	3	DRY		
	TPS6223-1.5 ⁽³⁾	1.5 V	3	DRY		
	TPS62236	1.85V	2	DRY	TPS62236DRY	OR
	TPS6223-2.0 ⁽³⁾	2.0 V	3	DRY		
	TPS62234	2.1 V	3	DRY	TPS62234DRY	OH
	TPS62238	2.25 V	3	DRY	TPS62238DRY	ON
	TPS622310	2.3 V	3	DRY	TPS622310DRY	OT
	TPS6223-2.7 ⁽³⁾	2.7 V	3	DRY		
	TPS6223-2.9 ⁽³⁾	2.9 V	3	DRY		
	TPS62233	3.0 V	3	DRY	TPS62233DRY	OG
TPS62237	3.3V	2	DRY	TPS62237DRY	OS	

- (1) The DRY package is available in tape on reel. Add R suffix to order quantities of 3000 parts per reel, T suffix for 250 parts per reel.
 (2) Contact TI for other fixed output voltage options
 (3) Device status is product preview, contact TI for more details

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) ⁽¹⁾

		VALUE	UNIT
V _I	Voltage at VIN and SW Pin ⁽²⁾	-0.3 to 7	V
	Voltage at EN, MODE Pin ⁽²⁾	-0.3 to V _{IN} +0.3, ≤7	V
	Voltage at FB Pin ⁽²⁾	-0.3 to 3.6	V
Peak output current		internally limited	A
ESD rating ⁽³⁾	HBM Human body model	2	kV
	CDM Charge device model	1	
	Machine model	200	V
Power dissipation		Internally limited	
T _J	Maximum operating junction temperature	-40 to 125	°C
T _{stg}	Storage temperature range	-65 to 150	°C

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
 (2) All voltage values are with respect to network ground terminal.
 (3) The human body model is a 100-pF capacitor discharged through a 1.5-kΩ resistor into each pin. The machine model is a 200-pF capacitor discharged directly into each pin.

DISSIPATION RATINGS⁽¹⁾

PACKAGE	R _{θJA}	POWER RATING FOR T _A ≤ 25°C	DERATING FACTOR ABOVE T _A = 25°C
1 × 1.5 SON	234°C/W ⁽²⁾	420 mW	4.2 mW/°C

- (1) Maximum power dissipation is a function of T_{J(max)}, θ_{JA} and T_A. The maximum allowable power dissipation at any allowable ambient temperature is P_D = [T_{J(max)} – T_A] / θ_{JA}.
- (2) This thermal data is measured with high-K board (4 layers board according to JESD51-7 JEDEC standard).

RECOMMENDED OPERATING CONDITIONS

operating ambient temperature T_A = –40 to 85°C (unless otherwise noted)⁽¹⁾

		MIN	NOM	MAX	UNIT
Supply voltage V _{IN} ⁽²⁾		2.05		6	V
Effective inductance			2.2		μH
Effective capacitance		2.0	4.7		μF
Recommended minimum supply voltage	V _{OUT} ≤ V _{IN} - 1 V ⁽³⁾	500 mA maximum I _{OUT} ⁽⁴⁾		3.0	3.6
		350mA maximum I _{OUT} ⁽⁵⁾		2.5	2.7
	V _{OUT} ≤ 1.8V	60 mA maximum output current ⁽⁵⁾		2.05	
Operating virtual junction temperature range, T _J		–40		125	°C

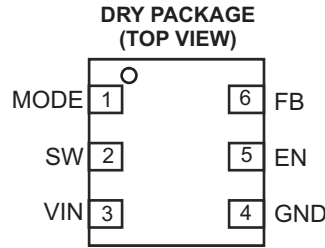
- (1) In applications where high power dissipation and/or poor package thermal resistance is present, the maximum ambient temperature may have to be derated. Maximum ambient temperature (T_{A(max)}) is dependent on the maximum operating junction temperature (T_{J(max)}), the maximum power dissipation of the device in the application (P_{D(max)}), and the junction-to-ambient thermal resistance of the part/package in the application (θ_{JA}), as given by the following equation: T_{A(max)} = T_{J(max)} – (θ_{JA} × P_{D(max)}).
- (2) The minimum required supply voltage for startup is 2.05 V. The part is functional down to the falling UVL (Under Voltage Lockout) threshold.
- (3) For a voltage difference between minimum V_{IN} and V_{OUT} of ≥ 1 V
- (4) Typical value applies for T_A = 25°C, maximum value applies for T_A = 70°C with T_J ≤ 125°C, PCB layout needs to support proper thermal performance.
- (5) Typical value applies for T_A = 25°C, maximum value applies for T_A = 85°C with T_J ≤ 125°C, PCB layout needs to support proper thermal performance.

ELECTRICAL CHARACTERISTICS

$V_{IN} = 3.6V$, $V_{OUT} = 1.8V$, $EN = V_{IN}$, $MODE = GND$, $T_A = -40^{\circ}C$ to $85^{\circ}C$ ⁽¹⁾ typical values are at $T_A = 25^{\circ}C$ (unless otherwise noted), $C_{IN} = 2.2\mu F$, $L = 2.2\mu H$, $C_{OUT} = 4.7\mu F$, see parameter measurement information

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT	
SUPPLY							
V_{IN}	Input voltage range ⁽²⁾		2.05		6	V	
I_Q	Operating quiescent current	$I_{OUT} = 0mA$. PFM mode enabled (Mode = 0) device not switching		22	40	μA	
		$I_{OUT} = 0mA$. PFM mode enabled (Mode = 0) device switching, $V_{IN} = 3.6V$, $V_{OUT} = 1.2V$		25		μA	
		$I_{OUT} = 0mA$. Switching with no load (MODE/DATA = V_{IN}), PWM operation, $V_{OUT} = 1.8V$, $L = 2.2\mu H$		3		mA	
I_{SD}	Shutdown current	$EN = GND$ ⁽³⁾		0.1	1	μA	
UVLO	Undervoltage lockout threshold	Falling		1.8	1.9	V	
		Rising		1.9	2.05	V	
ENABLE, MODE THRESHOLD							
$V_{IH\ TH}$	Threshold for detecting high EN, MODE	$2.05V \leq V_{IN} \leq 6V$, rising edge		0.8	1	V	
$V_{IL\ TH\ HYS}$	Threshold for detecting low EN, MODE	$2.05V \leq V_{IN} \leq 6V$, falling edge	0.4	0.6		V	
I_{IN}	Input bias Current, EN, MODE	$EN, MODE = GND$ or $V_{IN} = 3.6V$		0.01	0.5	μA	
POWER SWITCH							
$R_{DS(ON)}$	High side MOSFET on-resistance	$V_{IN} = 3.6V$, $T_{Jmax} = 85^{\circ}C$; $R_{DS(ON)}$ max value		600	850	m Ω	
	Low Side MOSFET on-resistance			350	480		
I_{LIMF}	Forward current limit MOSFET high-side	$V_{IN} = 3.6V$, open loop		690	850	1050	mA
	Forward current limit MOSFET low side			550	840	1220	mA
T_{SD}	Thermal shutdown	Increasing junction temperature		150		$^{\circ}C$	
	Thermal shutdown hysteresis	Decreasing junction temperature		20		$^{\circ}C$	
CONTROLLER							
t_{ONmin}	Minimum ON time	$V_{IN} 3.6V$, $V_{OUT} = 1.8V$, Mode = high, $I_{OUT} = 0mA$		135		ns	
t_{OFFmin}	Minimum OFF time			40		ns	
OUTPUT							
V_{REF}	Internal Reference Voltage			0.70		V	
V_{OUT}	Output voltage accuracy ⁽⁴⁾	$V_{IN} = 3.6V$, Mode = GND, device operating in PFM Mode, $I_{OUT} = 0mA$		0%			
		$V_{IN} = 3.6V$, MODE = V_{IN} , $I_{OUT} = 0mA$	$T_A = 25^{\circ}C$	-2.0%		2.0%	
			$T_A = -40^{\circ}C$ to $85^{\circ}C$	-2.5%		2.5%	
	DC output voltage load regulation	PWM operation, Mode = $V_{IN} = 3.6V$, $V_{OUT} = 1.8V$		0.001		%/mA	
DC output voltage line regulation	$I_{OUT} = 0mA$, Mode = V_{IN} , $2.05V \leq V_{IN} \leq 6V$		0		%/V		
t_{Start}	Start-up Time	Time from active EN to $V_{OUT} = 1.8V$, $V_{IN} = 3.6V$, 10 Ω load		100		μs	
I_{LK_SW}	Leakage current into SW pin	$V_{IN} = V_{OUT} = V_{SW} = 3.6V$, $EN = GND$ ⁽⁵⁾		0.1	0.5	μA	

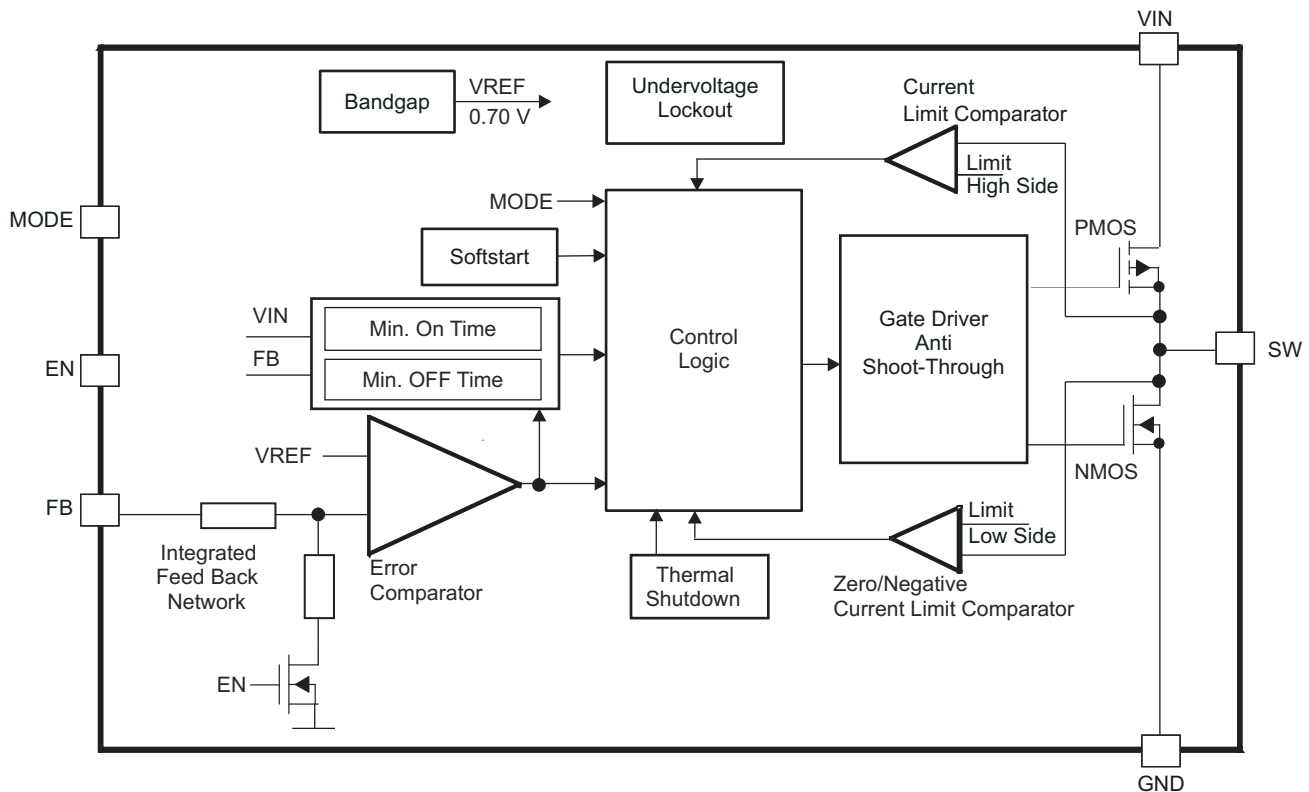
- In applications where high power dissipation and/or poor package thermal resistance is present, the maximum ambient temperature may have to be derated. Maximum ambient temperature ($T_{A(max)}$) is dependent on the maximum operating junction temperature ($T_{J(max)}$), the maximum power dissipation of the device in the application ($P_D(max)$), and the junction-to-ambient thermal resistance of the part/package in the application (θ_{JA}), as given by the following equation: $T_{A(max)} = T_{J(max)} - (\theta_{JA} \times P_D(max))$.
- The minimum required supply voltage for startup is 2.05V. The part is functional down to the falling UVL (Under Voltage Lockout) threshold
- Shutdown current into VIN pin, includes internal leakage
- $V_{IN} = V_O + 1.0V$
- The internal resistor divider network is disconnected from FB pin.



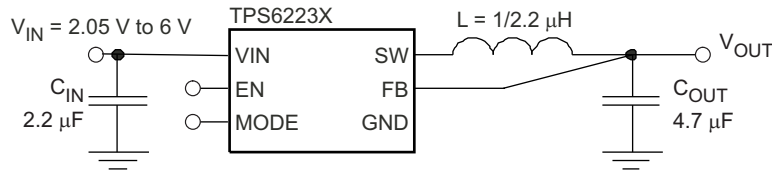
PIN FUNCTIONS

PIN		I/O	DESCRIPTION
NAME	NO		
VIN	3	PWR	V _{IN} power supply pin.
GND	4	PWR	GND supply pin
EN	5	IN	This is the enable pin of the device. Pulling this pin to low forces the device into shutdown mode. Pulling this pin to high enables the device. This pin must be terminated.
SW	2	OUT	This is the switch pin and is connected to the internal MOSFET switches. Connect the inductor to this terminal
FB	6	IN	Feedback Pin for the internal regulation loop. Connect this pin directly to the output capacitor.
MODE	1	IN	MODE pin = high forces the device to operate in PWM mode. Mode = low enables the Power Save Mode with automatic transition from PFM (Pulse frequency mode) to PWM (pulse width modulation) mode.

FUNCTIONAL BLOCK DIAGRAM



PARAMETER MEASUREMENT INFORMATION



C_{IN} : Murata GRM155R60J225ME15D 2.2 μ F 0402 size

C_{OUT} : Murata GRM188R60J475ME 4.7 μ F 0603 size, $V_{OUT} \geq 1.8$ V

C_{OUT} : Taiyo Yuden AMK105BJ475MV 4.7 μ F 0402 size, $V_{OUT} = 1.2$ V

L: Murata LQM2HPN1R0MJ0 1 μ H, LQM2HPN2R2MJ0 2.2 μ H,
size 2.5x2.0x1.2mm

TYPICAL CHARACTERISTICS

Table of Graphs

			FIGURE
η	Efficiency	vs Load current	1, 2, 3, 4, 5, 6, 7
η	Efficiency	vs Output Current	8, 9, 10, 11
V_O	Output voltage	vs Output current	12, 13, 14, 15, 16, 17
	Switching frequency	vs Output current	18, 19, 20, 21, 22, 23, 24, 25, 26, 27
I_Q	Quiescent current	vs Ambient temperature	28
I_{SD}	Shutdown current	vs Ambient temperature	29
$r_{DS(ON)}$	PMOS Static drain-source on-state resistance	vs Supply voltage and ambient temperature	30
	NMOS Static drain-source on-state resistance	vs Supply voltage and ambient temperature	31
PSRR	Power supply rejection ratio	vs Frequency	32
	Typical operation		33, 34, 35
	Line transient response	PFM	36
		PWM	37
	Mode transition PFM / forced PWM		38
	AC - load regulation performance		39, 40, 41
	Load transient response		42, 43, 44, 45
	Start-up		46, 47
	Spurious Output Noise, 12R Load		48
	Spurious Output Noise, 100R Load		49

TYPICAL CHARACTERISTICS (continued)

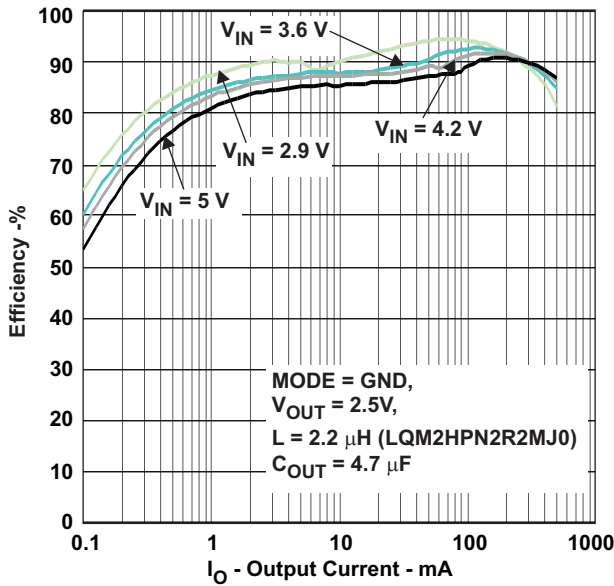


Figure 1. Efficiency PFM/PWM Mode 2.5V Output Voltage

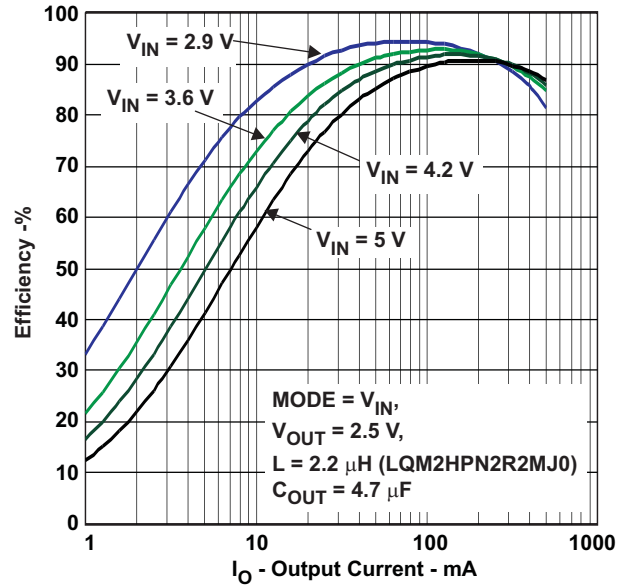


Figure 2. Efficiency Forced PWM Mode 2.5V Output Voltage

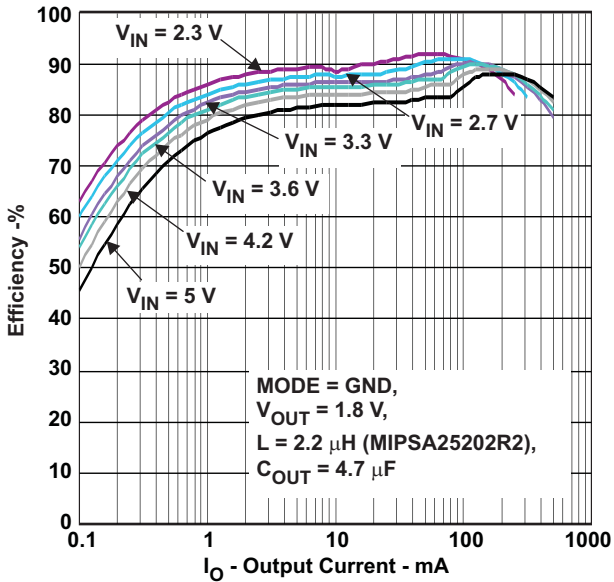


Figure 3. Efficiency PFM/PWM MODE 1.8V Output Voltage

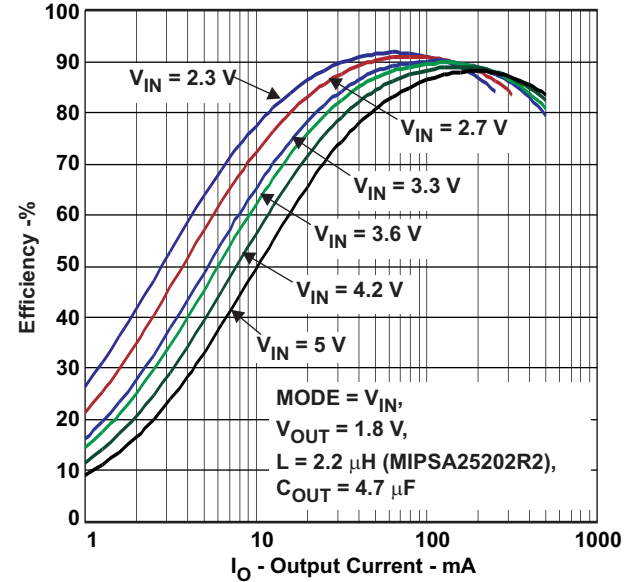


Figure 4. Efficiency Forced PWM Mode 1.8V Output voltage

TYPICAL CHARACTERISTICS (continued)

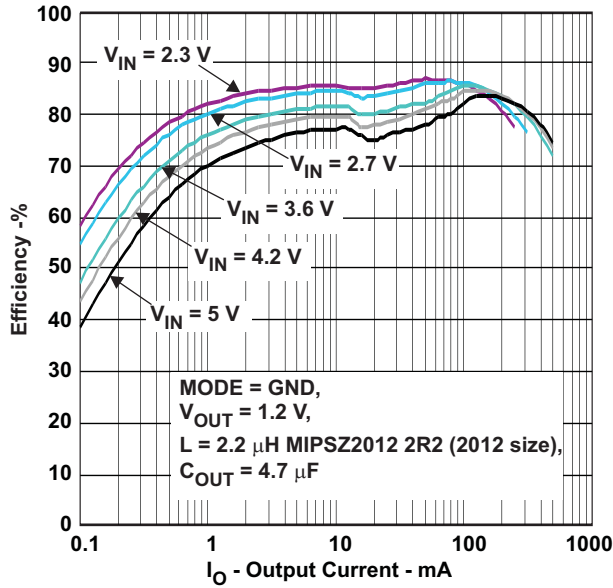


Figure 5. Efficiency PFM/PWM Mode 1.2V Output voltage

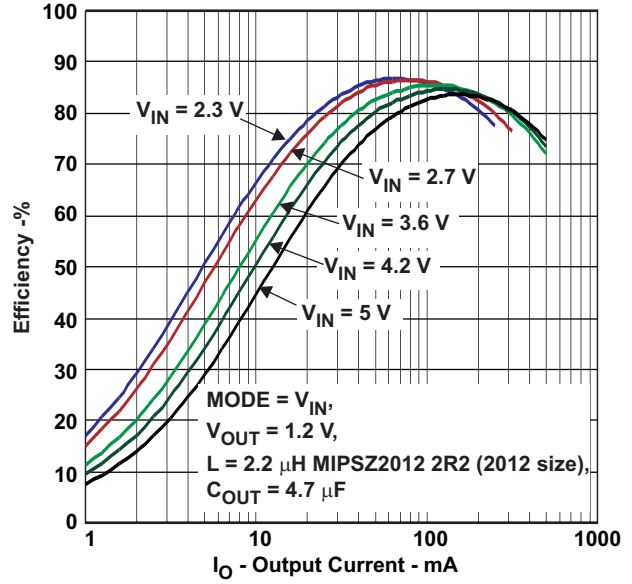


Figure 6. Efficiency Forced PWM Mode 1.2V Output Voltage

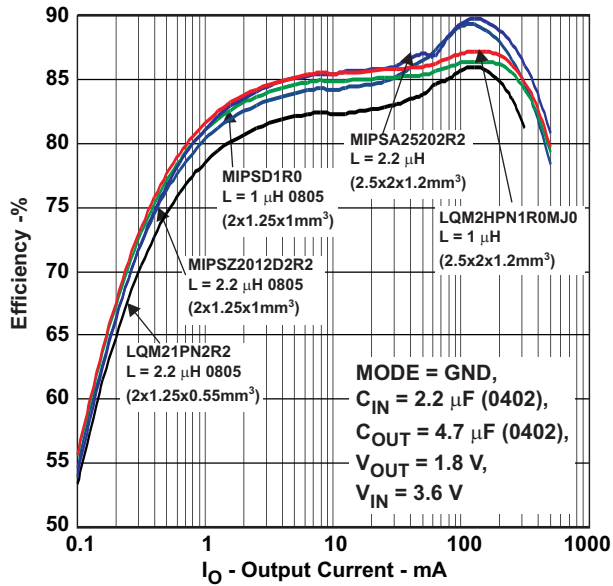


Figure 7. Comparison Efficiency vs Inductor Value and Size

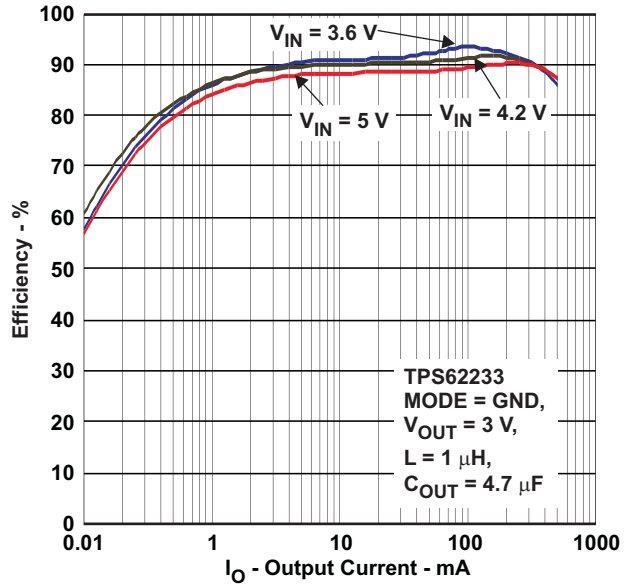


Figure 8. Comparison Efficiency vs I_OUT – TPS62233

TYPICAL CHARACTERISTICS (continued)

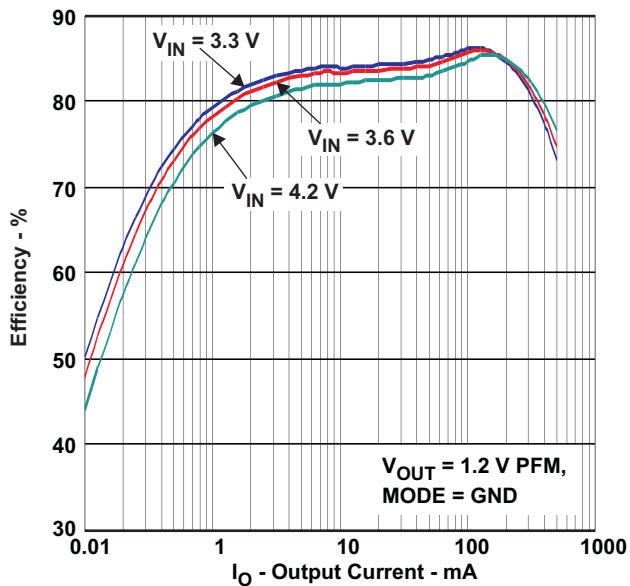


Figure 9. Comparison Efficiency vs I_{OUT} – TPS62235

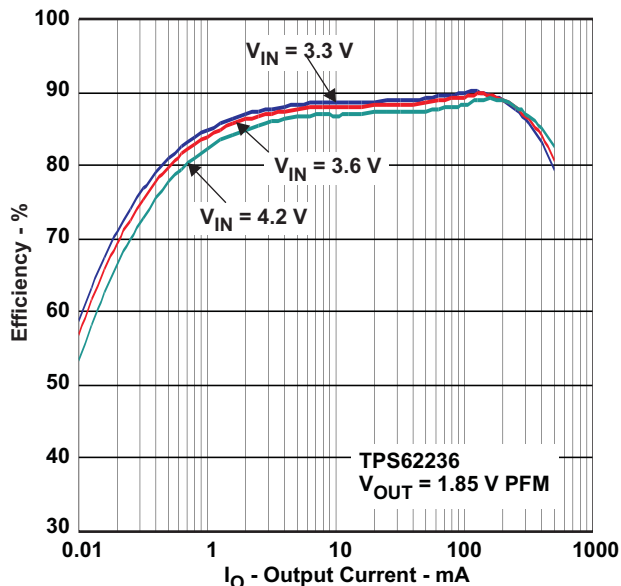


Figure 10. Comparison Efficiency vs I_{OUT} – TPS62236

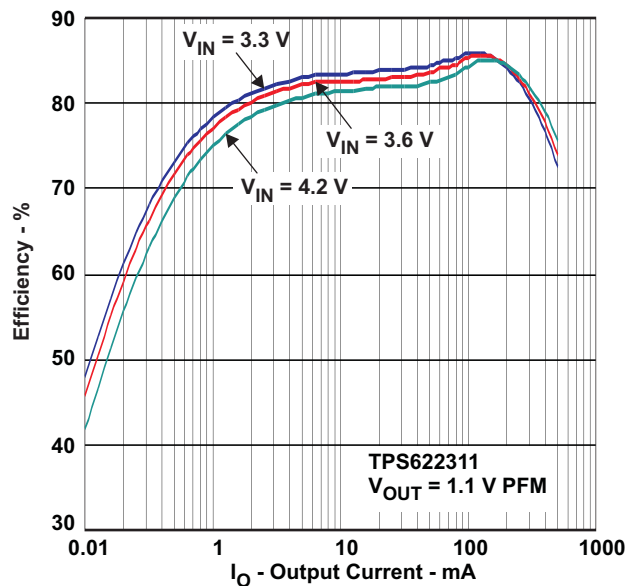


Figure 11. Comparison Efficiency vs I_{OUT} – TPS622311

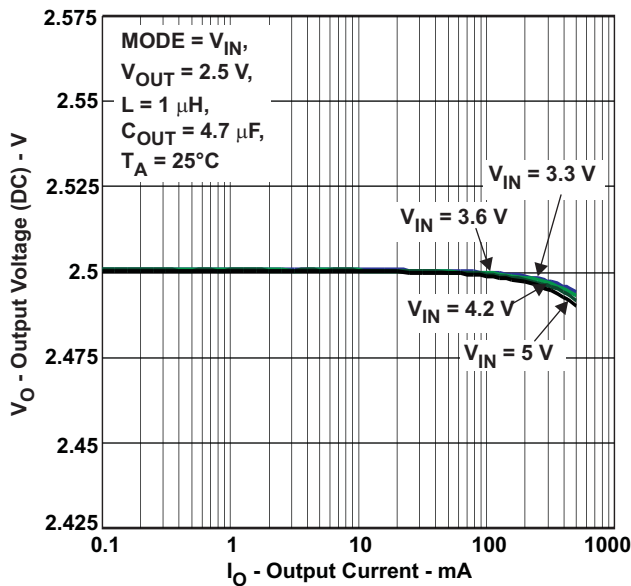


Figure 12. 2.5V Output Voltage Accuracy forced PWM Mode

TYPICAL CHARACTERISTICS (continued)

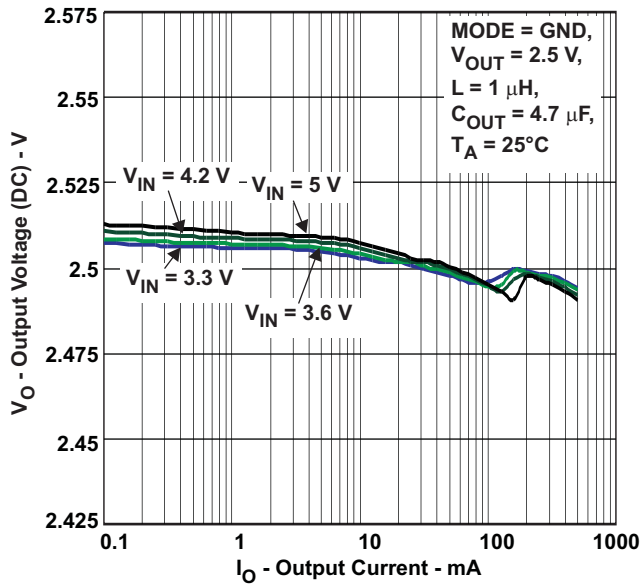


Figure 13. 2.5V Output Voltage Accuracy PFM/PWM Mode

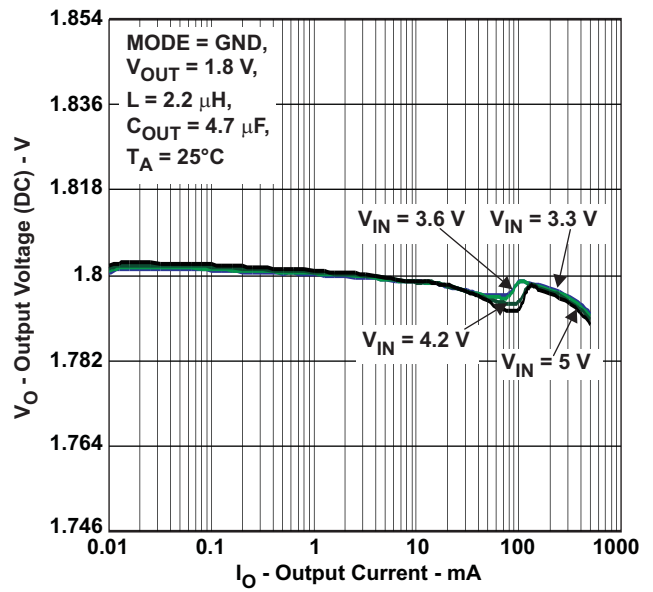


Figure 14. 1.8V Output Voltage Accuracy PFM/PWM Mode

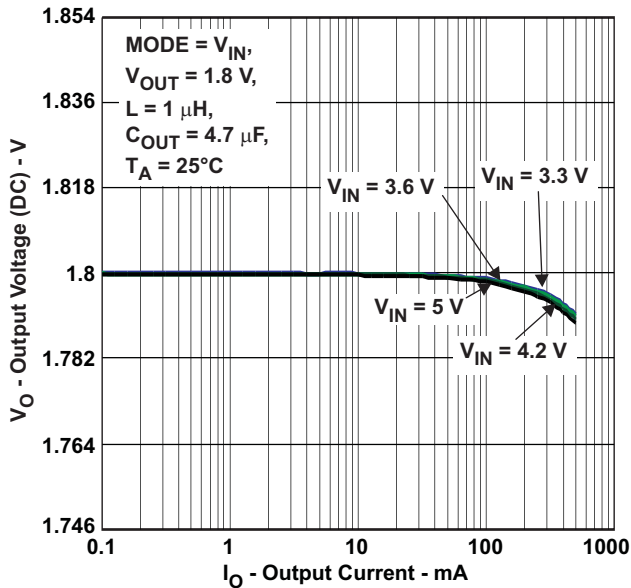


Figure 15. 1.8V Output Voltage Accuracy Forced PWM MODE

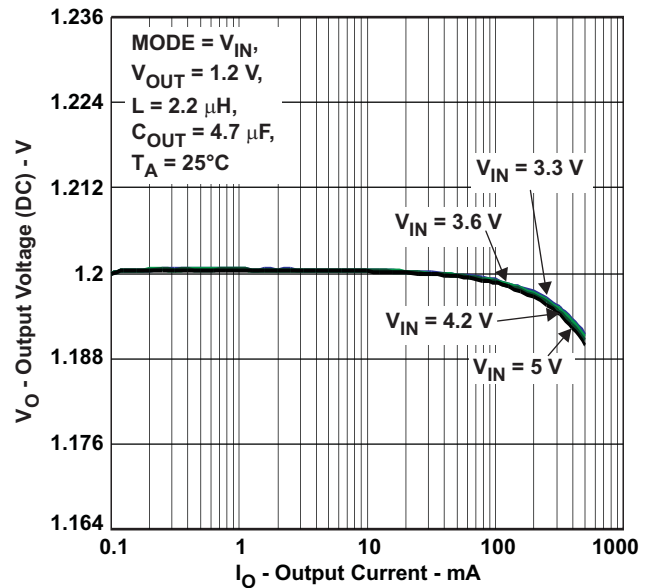


Figure 16. 1.2V Output Voltage Accuracy Forced PWM MODE

TYPICAL CHARACTERISTICS (continued)

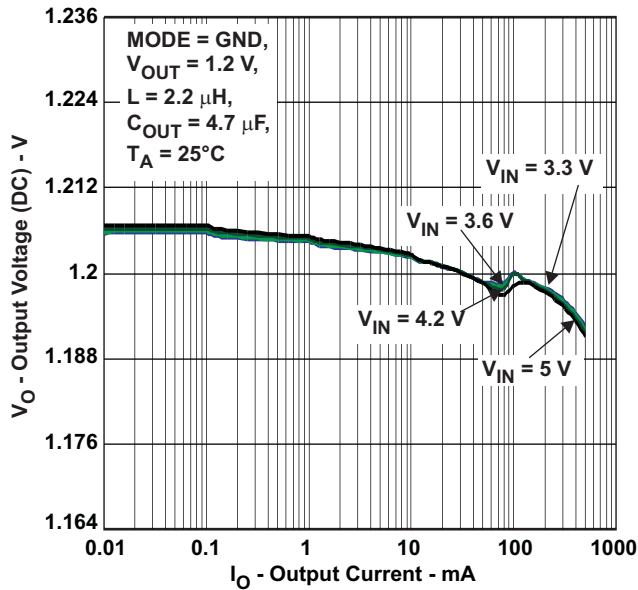


Figure 17. 1.2V Output Voltage Accuracy PFM/PWM MODE

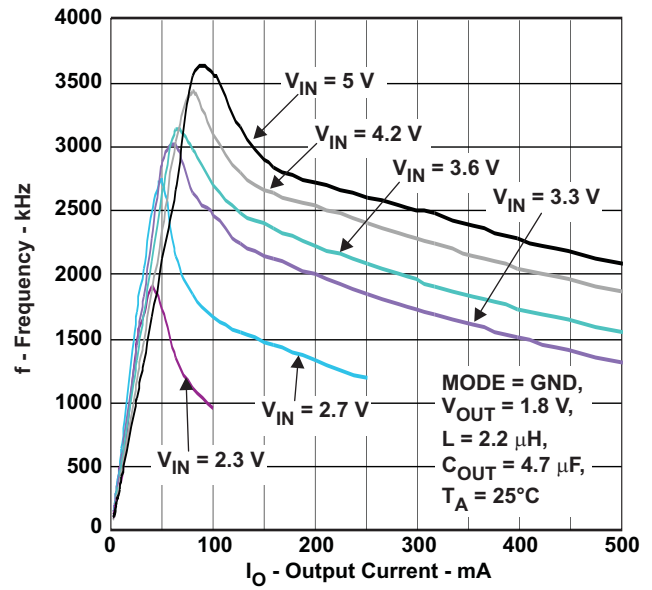


Figure 18. Switching Frequency vs Output Current, 1.8V Output Voltage MODE = GND

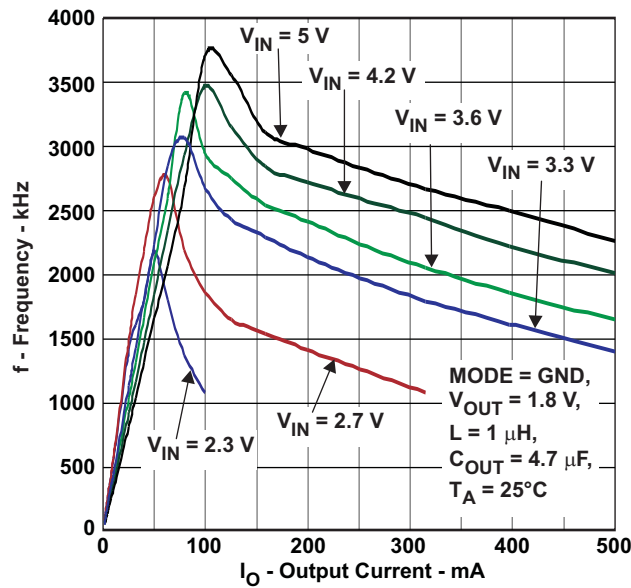


Figure 19. Switching Frequency vs Output Current, 1.8V Output Voltage MODE = GND

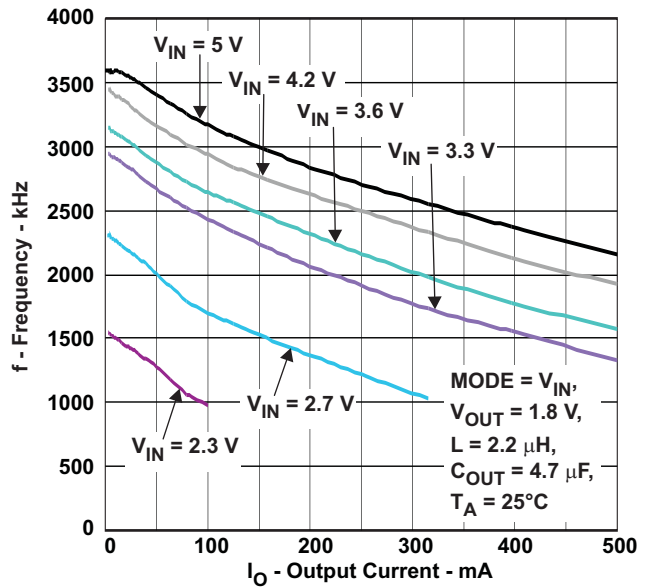


Figure 20. Switching Frequency vs Output Current, 1.8V Output Voltage MODE = V_{IN}

TYPICAL CHARACTERISTICS (continued)

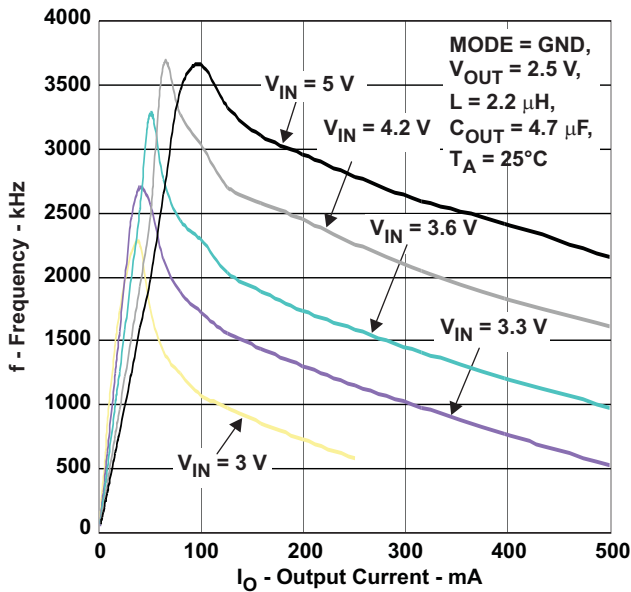


Figure 21. Switching Frequency vs Output Current, 2.5V Output Voltage MODE = GND

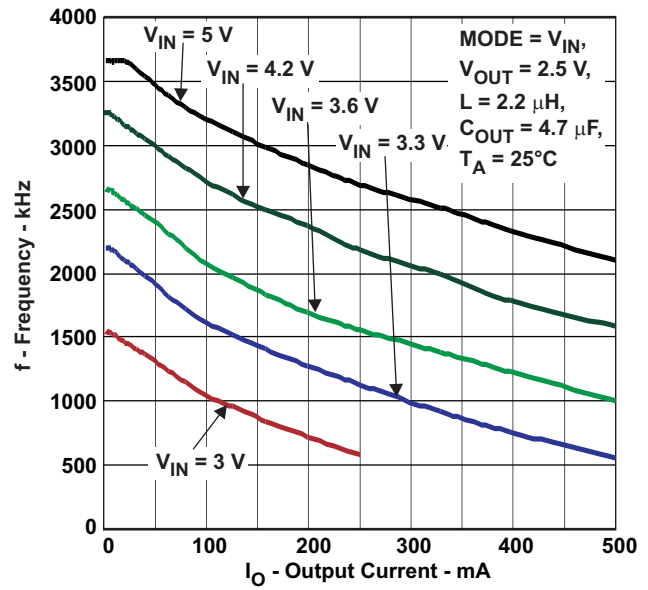


Figure 22. Switching Frequency vs Output Current, 2.5V Output Voltage MODE = V_{IN}

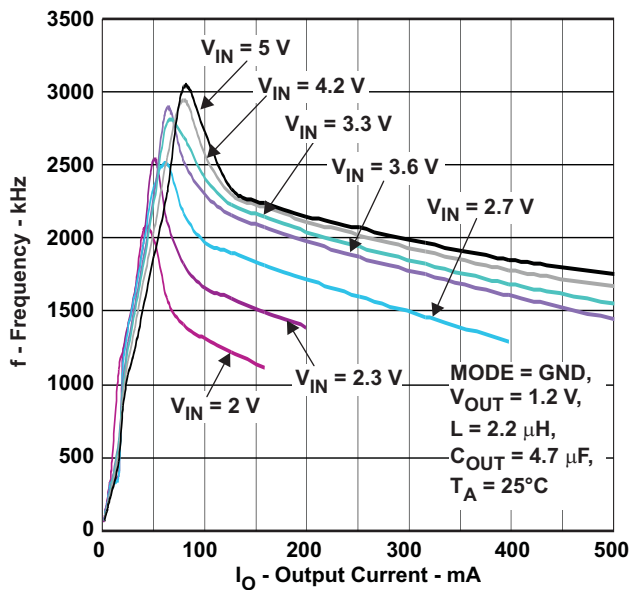


Figure 23. Switching Frequency vs Output Current, 1.2V Output Voltage MODE = GND

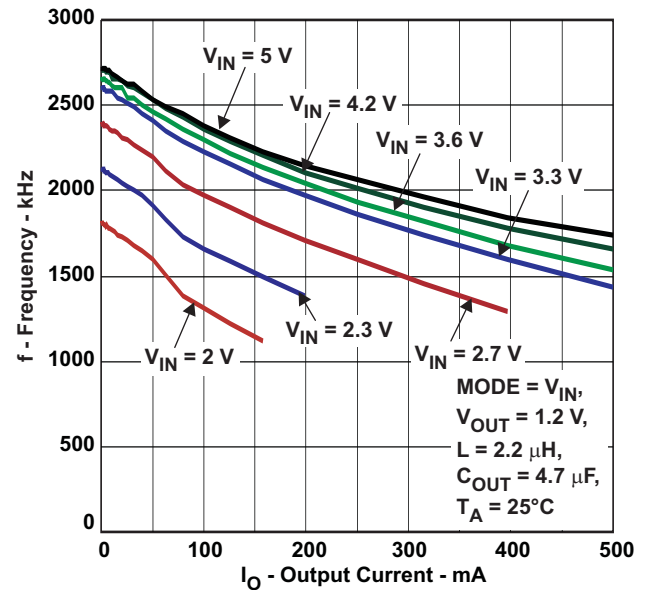


Figure 24. Switching Frequency vs Output Current, 1.2V Output Voltage MODE = V_{IN}

TYPICAL CHARACTERISTICS (continued)

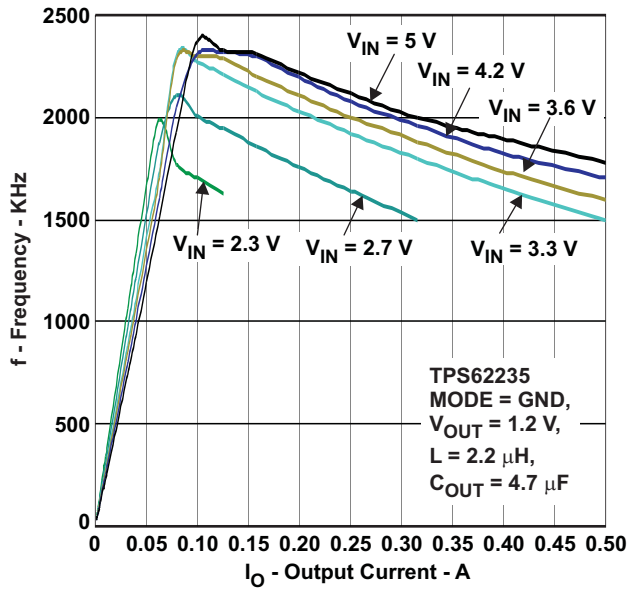


Figure 25. Switching Frequency vs Output Current, 1.2V Output Voltage MODE = PFM – TPS62235

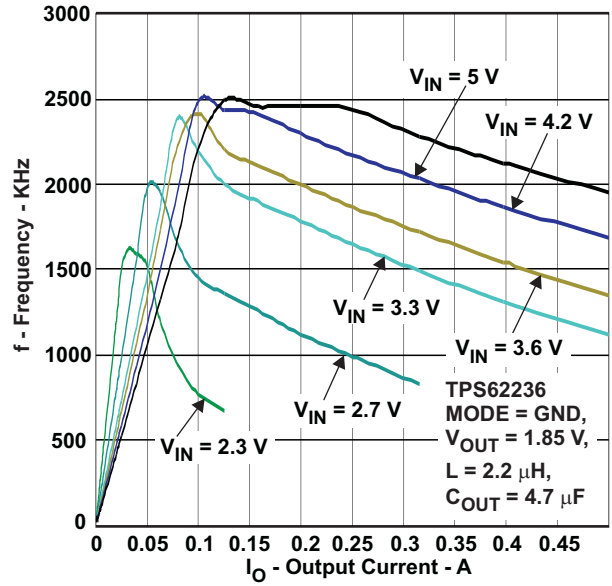


Figure 26. Switching Frequency vs Output Current, 1.85V Output Voltage MODE = PFM – TPS62236

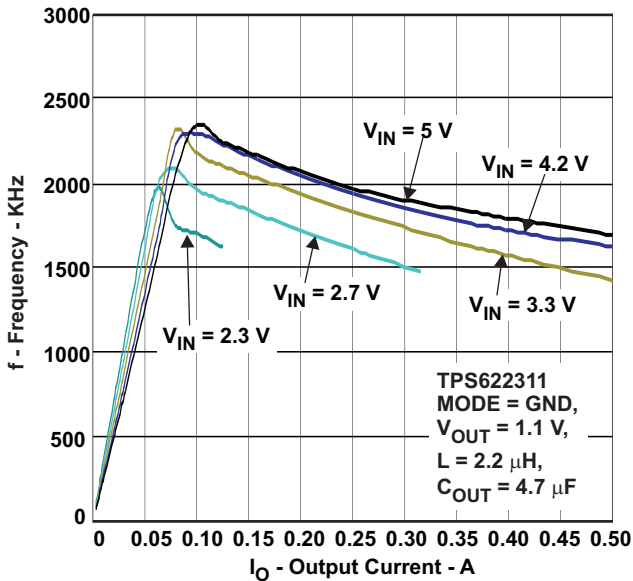


Figure 27. Switching Frequency vs Output Current, 1.1V Output Voltage MODE = PFM – TPS622311

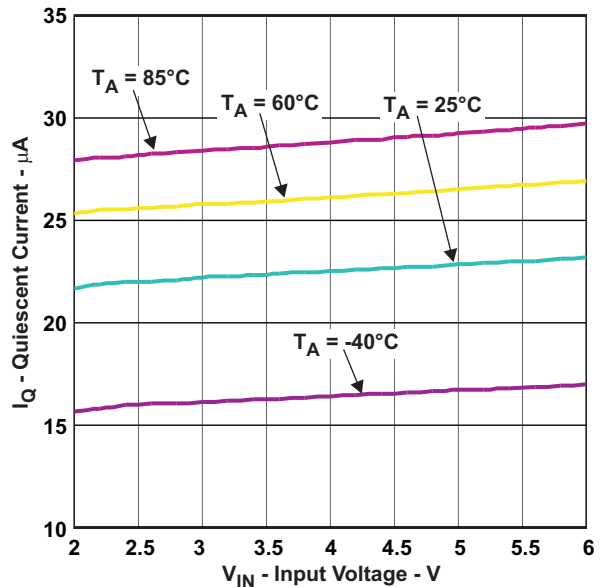


Figure 28. Quiescent Current I_Q vs Ambient Temperature T_A

TYPICAL CHARACTERISTICS (continued)

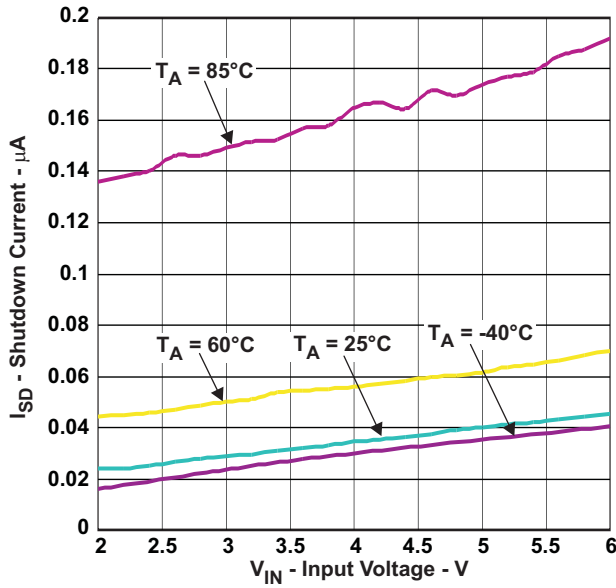


Figure 29. Shutdown Current I_{SD} vs Ambient Temperature T_A

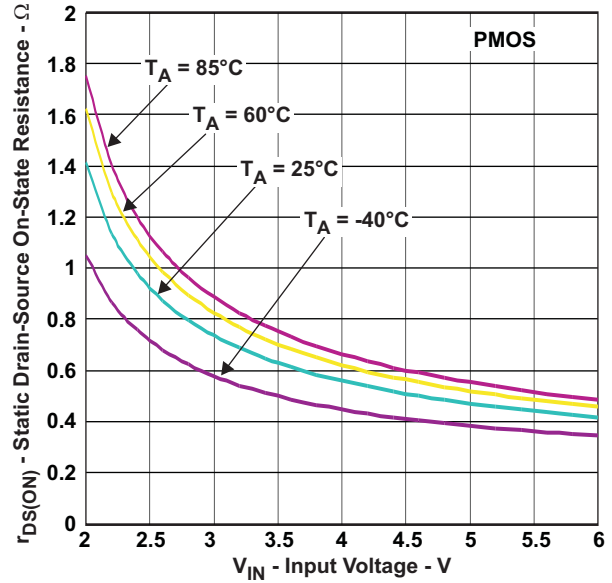


Figure 30. PMOS $R_{DS(ON)}$ vs Supply Voltage V_{IN} and Ambient Temperature T_A

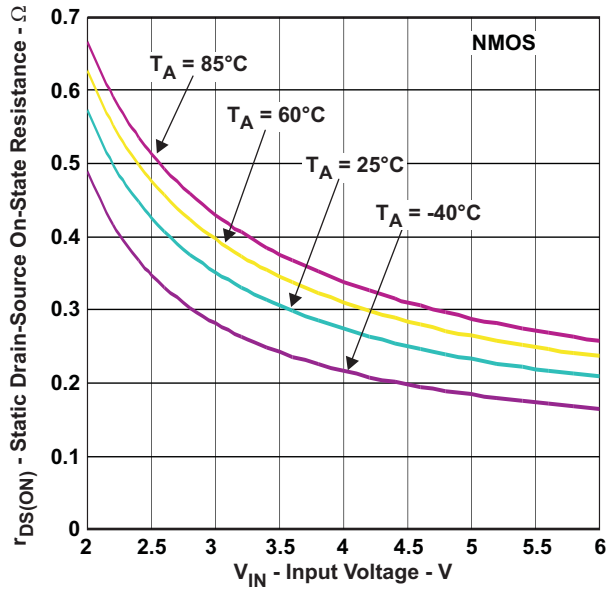


Figure 31. NMOS $R_{DS(ON)}$ vs Supply Voltage V_{IN} and Ambient Temperature T_A

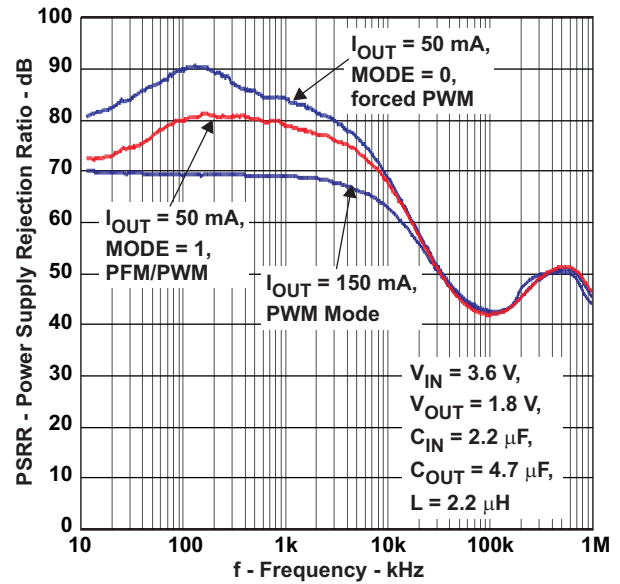


Figure 32. TPS62231 1.8V PSRR

TYPICAL CHARACTERISTICS (continued)

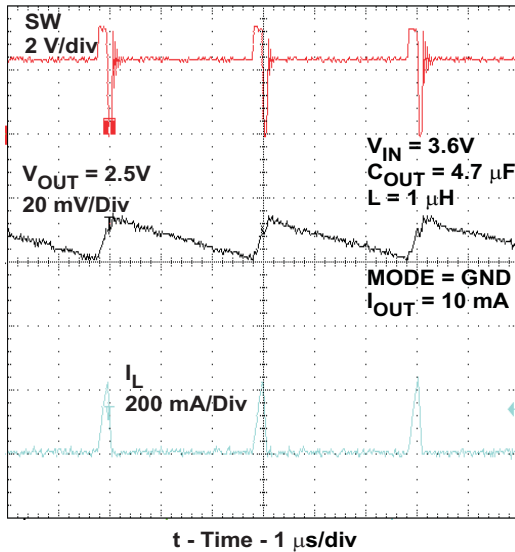


Figure 33. PFM Mode Operation $I_{OUT} = 10\text{mA}$

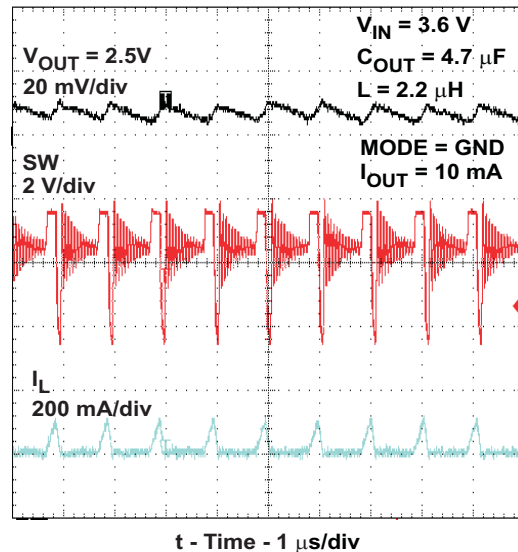


Figure 34. PFM Mode Operation $I_{OUT} = 10\text{mA}$

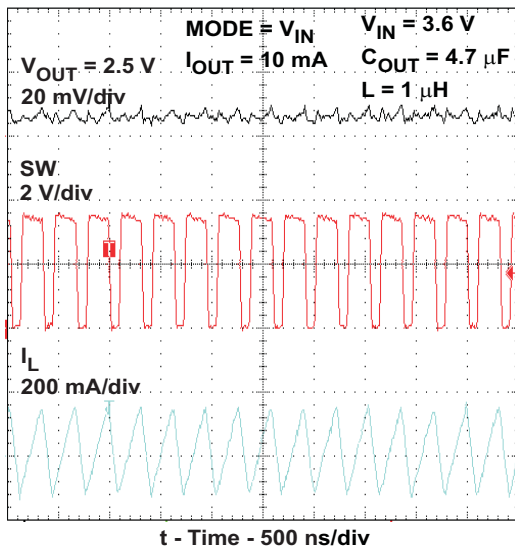


Figure 35. Forced PWM Mode Operation $I_{OUT} = 10\text{mA}$

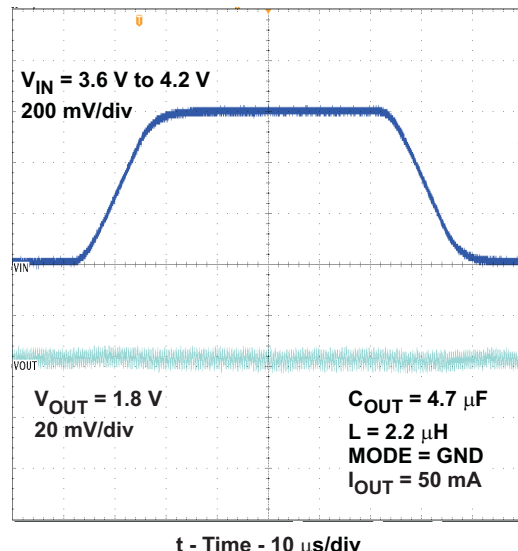
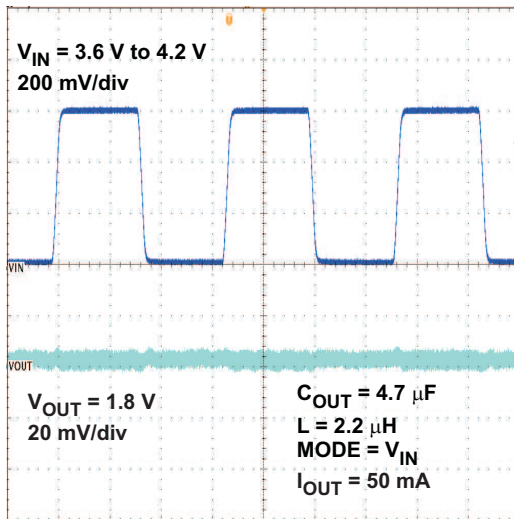


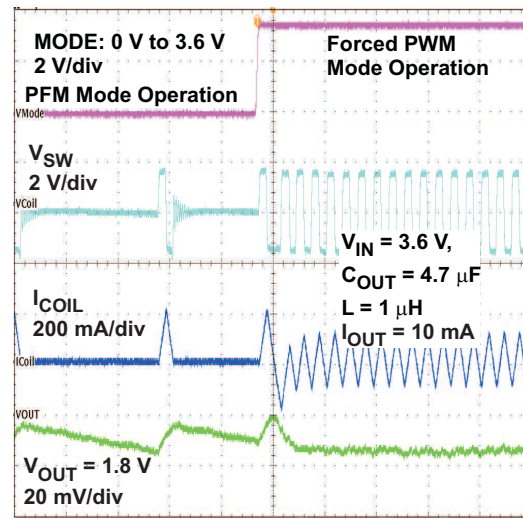
Figure 36. Line Transient Response PFM Mode

TYPICAL CHARACTERISTICS (continued)



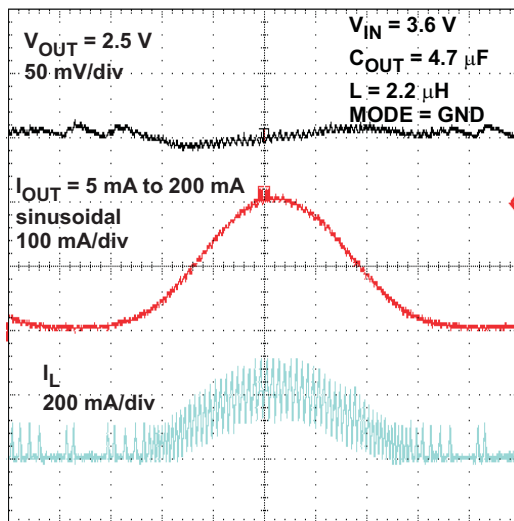
t - Time - 100 μs/div

Figure 37. Line Transient Response PWM Mode



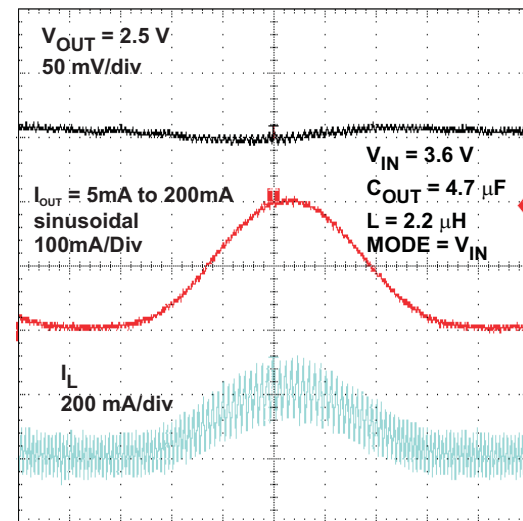
t - Time - 1 μs/div

Figure 38. Mode Transition PFM / Forced PWM Mode



t - Time - 5 μs/div

Figure 39. AC - Load Regulation Performance 2.5V VOUT PFM Mode



t - Time - 5 μs/div

Figure 40. AC - Load Regulation Performance 2.5V VOUT PWM Mode

TYPICAL CHARACTERISTICS (continued)

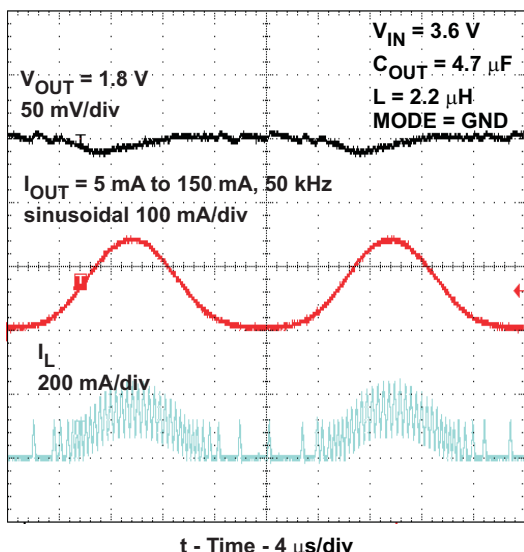


Figure 41. AC – Load Regulation Performance 1.8V V_{OUT} PFM Mode

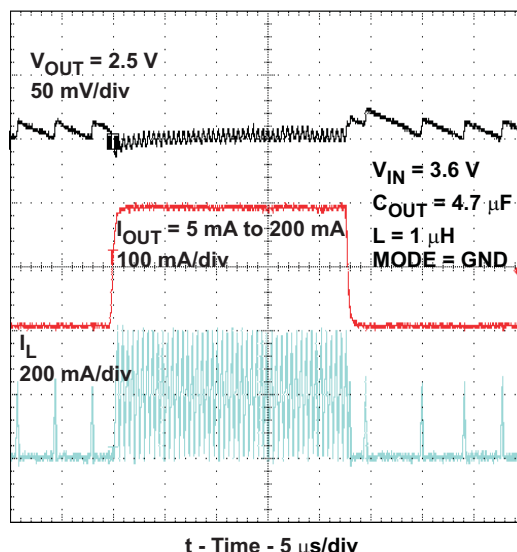


Figure 42. Load Transient Response 5mA to 200mA PFM to PWM Mode, V_{OUT} 2.5V

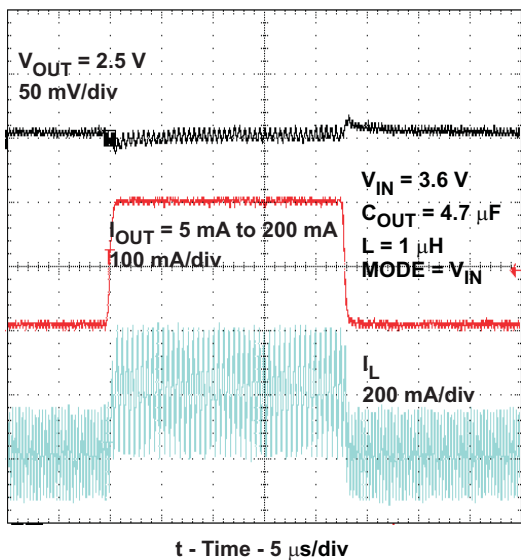


Figure 43. Load Transient Response 5mA to 200mA, Forced PWM Mode, V_{OUT} 2.5V

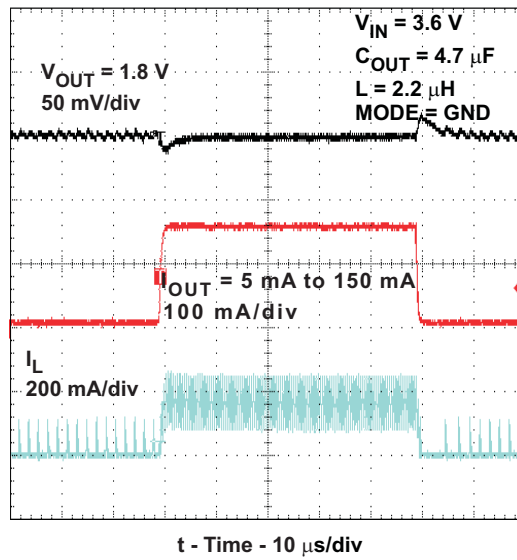


Figure 44. Load Transient Response 5mA to 150mA, PFM to PWM Mode, V_{OUT} 1.8V

TYPICAL CHARACTERISTICS (continued)

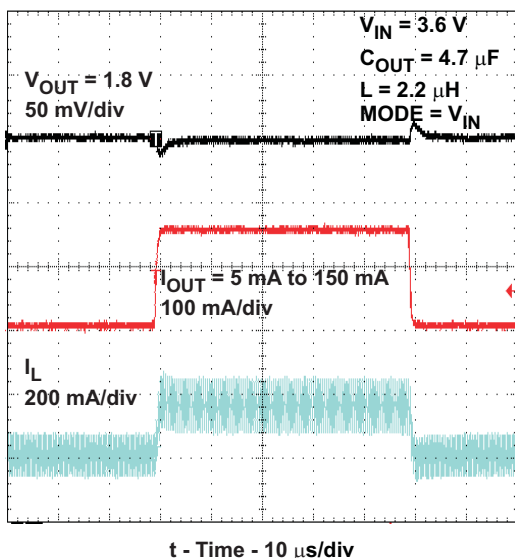


Figure 45. Load Transient Response 5mA to 150mA, Forced PWM Mode, V_{OUT} 1.8V

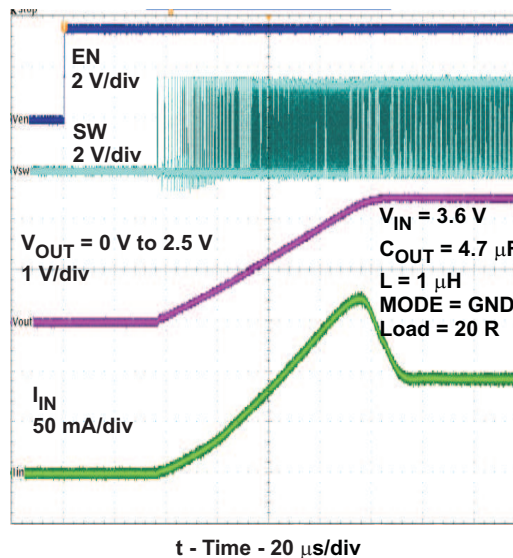


Figure 46. Start Up into 20Ω Load, V_{OUT} 2.5V

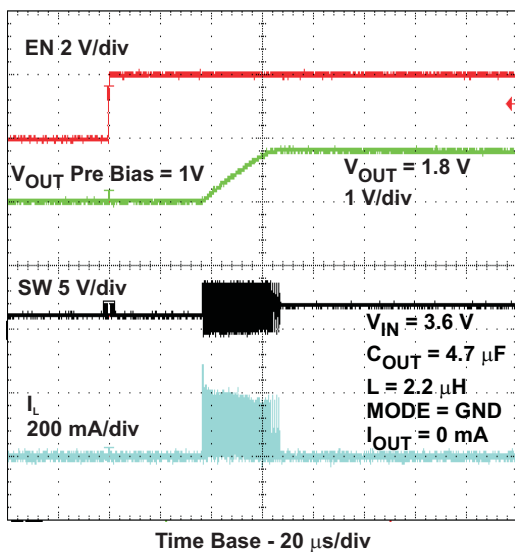


Figure 47. Startup in 1V Pre-biased Output

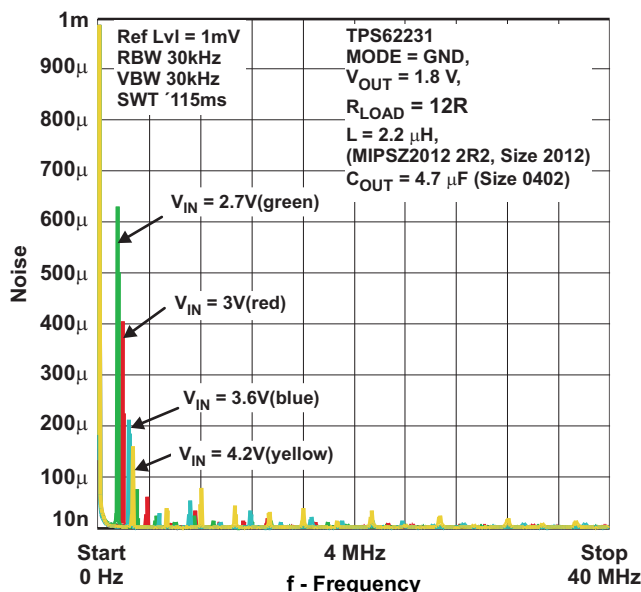
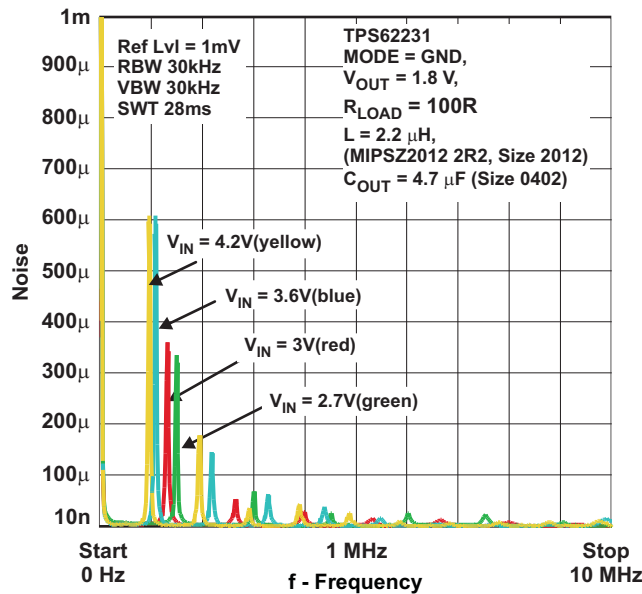


Figure 48. Spurious Output Noise, 12R Load, TPS62231

TYPICAL CHARACTERISTICS (continued)

Figure 49. Spurious Output Noise, 100R Load, TPS62231
DETAILED DESCRIPTION

The TPS6223X synchronous step down converter family includes a unique hysteretic PWM controller scheme which enables switch frequencies over 3MHz, excellent transient and AC load regulation as well as operation with cost competitive external components.

The controller topology supports forced PWM Mode as well as Power Save Mode operation. Power Save Mode operation reduces the quiescent current consumption down to 22µA and ensures high conversion efficiency at light loads by skipping switch pulses.

In forced PWM Mode, the device operates on a quasi fixed frequency, avoids pulse skipping, and allows filtering of the switch noise by external filter components.

The TPS6223X devices offer fixed output voltage options featuring smallest solution size by using only three external components.

The internal switch current limit of typical 850mA supports output currents of up to 500mA, depending on the operating condition.

A significant advantage of TPS6223X compared to other hysteretic PWM controller topologies is its excellent DC and AC load regulation capability in combination with low output voltage ripple over the entire load range which makes this part well suited for audio and RF applications.

OPERATION

Once the output voltage falls below the threshold of the error comparator, a switch pulse is initiated, and the high side switch is turned on. It remains turned on until a minimum on time of t_{ONmin} expires and the output voltage trips the threshold of the error comparator or the inductor current reaches the high side switch current limit. Once the high side switch turns off, the low side switch rectifier is turned on and the inductor current ramps down until the high side switch turns on again or the inductor current reaches zero.

In forced PWM Mode operation, negative inductor current is allowed to enable continuous conduction mode even at no load condition.

POWER SAVE MODE

Connecting the MODE pin to GND enables the automatic PWM and power-save mode operation. The converter operates in quasi fixed frequency PWM mode at moderate to heavy loads and in the PFM (Pulse Frequency Modulation) mode during light loads, which maintains high efficiency over a wide load current range.

In PFM Mode, the device starts to skip switch pulses and generates only single pulses with an on time of t_{ONmin} . The PFM Mode frequency depends on the load current and the external inductor and output capacitor values. The PFM Mode of TPS6223X is optimized for low output voltage ripple if small external components are used. Even at low output currents, the PFM frequency is above the audible noise spectrum and makes this operation mode suitable for audio applications.

The on time t_{ONmin} can be estimated to:

$$t_{ONmin} = \frac{V_{OUT}}{V_{IN}} \times 260 \text{ ns} \quad (1)$$

Therefore, the peak inductor current in PFM mode is approximately:

$$I_{LPMpeak} = \frac{(V_{IN} - V_{OUT})}{L} \times t_{ONmin} \quad (2)$$

With

- t_{ON} : High side switch on time [ns]
- V_{IN} : Input voltage [V]
- V_{OUT} : Output voltage [V]
- L : Inductance [μ H]
- $I_{LPMpeak}$: PFM inductor peak current [mA]

FORCED PWM MODE

Pulling the MODE pin high forces the converter to operate in a continuous conduction PWM mode even at light load currents. The advantage is that the converter operates with a quasi fixed frequency that allows simple filtering of the switching frequency for noise-sensitive applications. In this mode, the efficiency is lower compared to the power-save mode during light loads.

For additional flexibility, it is possible to switch from power-save mode to forced PWM mode during operation. This allows efficient power management by adjusting the operation of the converter to the specific system requirements.

100% DUTY CYCLE LOW DROPOUT OPERATION

The device starts to enter 100% duty cycle mode once the input voltage comes close to the nominal output voltage. In order to maintain the output voltage, the High Side switch is turned on 100% for one or more cycles.

With further decreasing V_{IN} the High Side MOSFET switch is turned on completely. In this case the converter offers a low input-to-output voltage difference. This is particularly useful in battery-powered applications to achieve longest operation time by taking full advantage of the whole battery voltage range.

The minimum input voltage to maintain regulation depends on the load current and output voltage, and can be calculated as:

$$V_{INmin} = V_{OUTmax} + I_{OUTmax} \times (R_{DS(on)max} + R_L) \quad (3)$$

With:

- I_{OUTmax} = maximum output current plus inductor ripple current
- $R_{DS(on)max}$ = maximum P-channel switch R_{DSon} .
- R_L = DC resistance of the inductor
- V_{OUTmax} = nominal output voltage plus maximum output voltage tolerance

UNDER VOLTAGE LOCKOUT

The under voltage lockout circuit prevents the device from misoperation at low input voltages. It prevents the converter from turning on the switch or rectifier MOSFET under undefined conditions. The TPS6223X devices have a UVLO threshold set to 1.8V (typical). Fully functional operation is permitted for input voltage down to the falling UVLO threshold level. The converter starts operation again once the input voltage trips the rising UVLO threshold level.

SOFT START

The TPS6223X has an internal soft-start circuit that controls the ramp up of the output voltage and limits the inrush current during start-up. This limits input voltage drops when a battery or a high-impedance power source is connected to the input of the converter.

The soft-start system generates a monotonic ramp up of the output voltage and reaches the nominal output voltage typically 100 μ s after EN pin was pulled high.

Should the output voltage not have reached its target value by this time, such as in the case of heavy load, the converter then operates in a current limit mode set by its switch current limits.

TPS6223X is able to start into a pre-biased output capacitor. The converter starts with the applied bias voltage and ramps the output voltage to its nominal value.

ENABLE / SHUTDOWN

The device starts operation when EN is set high and starts up with the soft start as previously described. For proper operation, the EN pin must be terminated and must not be left floating.

Pulling the EN pin low forces the device into shutdown, with a shutdown quiescent current of typically 0.1 μ A. In this mode, the P and N-channel MOSFETs are turned off, the internal resistor feedback divider is disconnected, and the entire internal-control circuitry is switched off.

The EN input can be used to control power sequencing in a system with various DC/DC converters. The EN pin can be connected to the output of another converter, to drive the EN pin high and getting a sequencing of supply rails.

SHORT-CIRCUIT PROTECTION

The TPS6223X integrates a High Side and Low Side MOSFET current limit to protect the device against heavy load or short circuit. The current in the switches is monitored by current limit comparators. When the current in the P-channel MOSFET reaches its current limit, the P-channel MOSFET is turned off and the N-channel MOSFET is turned on to ramp down the current in the inductor. The High Side MOSFET switch can only turn on again, once the current in the Low Side MOSFET switch has decreased below the threshold of its current limit comparator.

THERMAL SHUTDOWN

As soon as the junction temperature, T_J , exceeds 150°C (typical) the device goes into thermal shutdown. In this mode, the High Side and Low Side MOSFETs are turned-off. The device continues its operation when the junction temperature falls below the thermal shutdown hysteresis.

APPLICATION INFORMATION

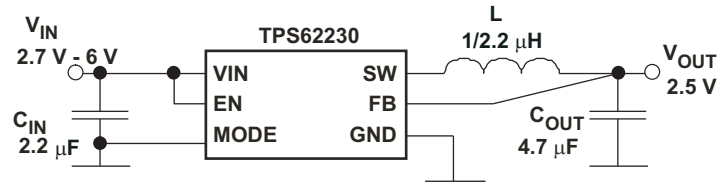


Figure 50. TPS62230 2.5V Output

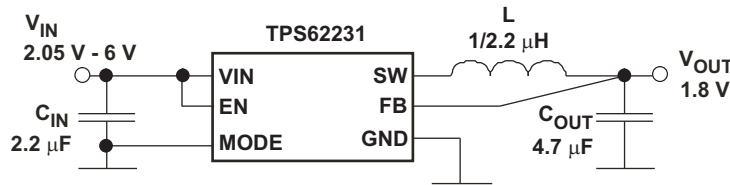


Figure 51. TPS62231 1.8V Output

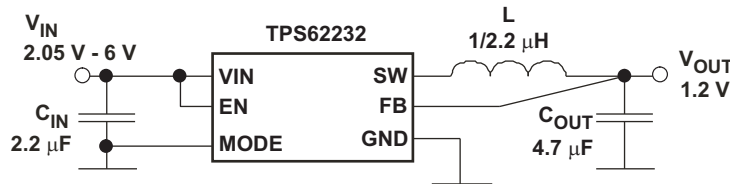


Figure 52. TPS62232 1.2V Output

OUTPUT FILTER DESIGN (INDUCTOR AND OUTPUT CAPACITOR)

The TPS6223X is optimized to operate with effective inductance values in the range of 0.7μH to 4.3μH and with effective output capacitance in the range of 2.0μF to 15μF. The internal compensation is optimized to operate with an output filter of $L = 1.0\mu\text{H}/2.2\mu\text{H}$ and $C_{\text{OUT}} = 4.7\mu\text{F}$. Larger or smaller inductor/capacitor values can be used to optimize the performance of the device for specific operation conditions. For more details, see the *CHECKING LOOP STABILITY* section.

INDUCTOR SELECTION

The inductor value affects its peak-to-peak ripple current, the PWM-to-PFM transition point, the output voltage ripple and the efficiency. The selected inductor has to be rated for its dc resistance and saturation current. The inductor ripple current (ΔI_L) decreases with higher inductance and increases with higher V_{IN} or V_{OUT} . Equation 4 calculates the maximum inductor current under static load conditions. The saturation current of the inductor should be rated higher than the maximum inductor current as calculated with Equation 5. This is recommended because during heavy load transient the inductor current will rise above the calculated value.

$$\Delta I_L = V_{\text{out}} \times \frac{1 - \frac{V_{\text{out}}}{V_{\text{in}}}}{L \times f} \quad (4)$$

$$I_{L_{\text{max}}} = I_{\text{outmax}} + \frac{\Delta I_L}{2} \quad (5)$$

With:

f = Switching Frequency

L = Inductor Value

ΔI_L = Peak to Peak inductor ripple current

$I_{L_{\text{max}}}$ = Maximum Inductor current

In high-frequency converter applications, the efficiency is essentially affected by the inductor AC resistance (i.e., quality factor) and to a smaller extent by the inductor DCR value. To achieve high efficiency operation, care should be taken in selecting inductors featuring a quality factor above 25 at the switching frequency. Increasing the inductor value produces lower RMS currents, but degrades transient response. For a given physical inductor size, increased inductance usually results in an inductor with lower saturation current.

The total losses of the coil consist of both the losses in the DC resistance, $R_{(DC)}$, and the following frequency-dependent components:

- The losses in the core material (magnetic hysteresis loss, especially at high switching frequencies)
- Additional losses in the conductor from the skin effect (current displacement at high frequencies)
- Magnetic field losses of the neighboring windings (proximity effect)
- Radiation losses

The following inductor series from different suppliers have been used with the TPS6223X converters.

Table 1. List of inductors

INDUCTANCE [μ H]	DIMENSIONS [mm ³]	INDUCTOR TYPE	SUPPLIER
1.0/2.2	2.5 × 2.0 × 1.2	LQM2HPN1R0MJ0	Murata
2.2	2.0 × 1.2 × 0.55	LQM21PN2R2	Murata
1.0/2.2	2.0 × 1.2 × 1.0	MIPSZ2012	FDK
1.0/2.2	2.0 × 2.5 × 1.2	MIPSA2520	FDK
1.0/2.2	2.0 × 1.2 × 1.0	KSLI2012 series	Hitachi Metal

OUTPUT CAPACITOR SELECTION

The unique hysteretic PWM control scheme of the TPS62230 allows the use of tiny ceramic capacitors. Ceramic capacitors with low ESR values have the lowest output voltage ripple and are recommended. The output capacitor requires either an X7R or X5R dielectric. Y5V and Z5U dielectric capacitors, aside from their wide variation in capacitance over temperature, become resistive at high frequencies.

At light load currents the converter operate in Power Save Mode and the output voltage ripple is dependent on the output capacitor value and the PFM peak inductor current. Higher output capacitor values minimize the voltage ripple in PFM Mode and tighten DC output accuracy in PFM Mode.

INPUT CAPACITOR SELECTION

Because of the nature of the buck converter having a pulsating input current, a low ESR input capacitor is required for best input voltage filtering and minimizing the interference with other circuits caused by high input voltage spikes. For most applications a 2.2 μ F to 4.7 μ F ceramic capacitor is recommended. The input capacitor can be increased without any limit for better input voltage filtering. Because ceramic capacitor loses up to 80% of its initial capacitance at 5V, it is recommended to use 4.7 μ F input capacitors for input voltages > 4.5V.

Take care when using only small ceramic input capacitors. When a ceramic capacitor is used at the input and the power is being supplied through long wires, such as from a wall adapter, a load step at the output or V_{IN} step on the input can induce ringing at the VIN pin. This ringing can couple to the output and be mistaken as loop instability or could even damage the part by exceeding the maximum ratings.

Table 2 shows a list of tested input/output capacitors.

Table 2. List of Capacitor

CAPACITANCE [μ F]	SIZE	CAPACITOR TYPE	SUPPLIER
2.2	0402	GRM155R60J225	Murata
4.7	0402	AMK105BJ475MV	Taiyo Yuden
4.7	0402	GRM155R60J475	Murata
4.7	0402	CL05A475MQ5NRNC	Samsung
4.7	0603	GRM188R60J475	Murata

CHECKING LOOP STABILITY

The first step of circuit and stability evaluation is to look from a steady-state perspective at the following signals:

- Switching node, SW
- Inductor current, I_L
- Output ripple voltage, $V_{OUT(AC)}$

These are the basic signals that need to be measured when evaluating a switching converter. When the switching waveform shows large duty cycle jitter or the output voltage or inductor current shows oscillations, the regulation loop may be unstable. This is often a result of board layout and/or L-C combination.

As a next step in the evaluation of the regulation loop, the load transient response is tested. The time between the application of the load transient and the turn on of the P-channel MOSFET, the output capacitor must supply all of the current required by the load. V_{OUT} immediately shifts by an amount equal to $\Delta I_{(LOAD)} \times ESR$, where ESR is the effective series resistance of C_{OUT} . $\Delta I_{(LOAD)}$ begins to charge or discharge C_O generating a feedback error signal used by the regulator to return V_{OUT} to its steady-state value. The results are most easily interpreted when the device operates in PWM mode.

During this recovery time, V_{OUT} can be monitored for settling time, overshoot or ringing that helps judge the converter's stability. Without any ringing, the loop has usually more than 45° of phase margin.

Because the damping factor of the circuitry is directly related to several resistive parameters (e.g., MOSFET $r_{DS(on)}$) that are temperature dependant, the loop stability analysis has to be done over the input voltage range, load current range, and temperature range.

LAYOUT CONSIDERATIONS

As for all switching power supplies, the layout is an important step in the design. Proper function of the device demands careful attention to PCB layout. Care must be taken in board layout to get the specified performance. If the layout is not carefully done, the regulator could show poor line and/or load regulation, stability issues as well as EMI problems. It is critical to provide a low inductance, impedance ground path. Therefore, use wide and short traces for the main current paths. The input capacitor should be placed as close as possible to the IC pins as well as the inductor and output capacitor.

Use a common Power GND node and a different node for the Signal GND to minimize the effects of ground noise. Keep the common path to the GND PIN, which returns the small signal components and the high current of the output capacitors as short as possible to avoid ground noise. The FB line should be connected to the output capacitor and routed away from noisy components and traces (e.g. SW line).

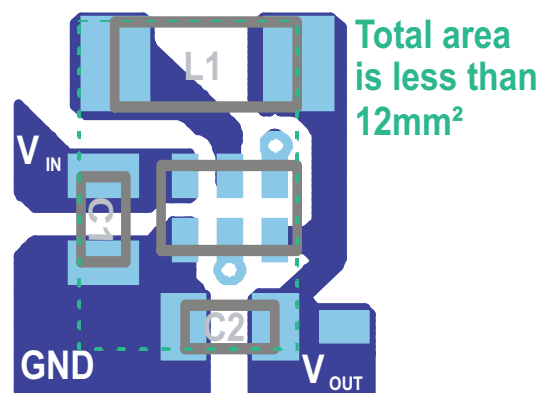


Figure 53. Recommended PCB Layout for TPS6223X

REVISION HISTORY

Changes from Original (April 2009) to Revision A Page

- Added device numbers TPS62233, TPS62234, TPS62238, TPS62239, and TPS622310 to the data sheet 1
-

Changes from Revision A (August 2009) to Revision B Page

- Added device numbers TPS62235, TPS62236, TPS62237, TPS622311 1
 - Changed the Title From: 3 MHz Ultra Small Step Down Converter in 1x1.5 SON Package To: 2 MHz / 3 MHz Ultra Small Step Down Converter in 1x1.5 SON Package 1
 - Changed Feature: From: 3 MHz switch frequency To: 2 MHz / 3 MHz switch frequency 1
 - Added [Figure 8](#) 8
 - Added [Figure 9](#) 8
 - Added [Figure 10](#) 8
 - Added [Figure 11](#) 9
 - Added [Figure 25](#) 12
 - Added [Figure 26](#) 12
 - Added [Figure 27](#) 13
 - Added [Figure 48](#) 18
 - Added [Figure 49](#) 18
-

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